AUTOMOTIVE GRADE

International

AUIRF2907Z

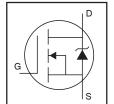
HEXFET[®] Power MOSFET

Features

- Advanced Process Technology
- Ultra Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

Description

Specifically designed for Automotive applications, this HEXFET[®] Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



V _{(BR)DSS}	75V
R _{DS(on)} max.	4.5m Ω
ID (Silicon Limited)	170A
L (Package Limited)	75A



G	D	s
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
$I_{\rm D} @ T_{\rm C} = 25^{\circ}{\rm C}$	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	170	А
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	120	1
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Package Limited)	75	1
I _{DM}	Pulsed Drain Current ①	680	1
$P_D @T_C = 25^{\circ}C$	Maximum Power Dissipation	300	W
	Linear Derating Factor	2.0	W/°C
V _{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ②	270	mJ
E _{AS} (tested)	Single Pulse Avalanche Energy Tested Value 🗇	690	1
I _{AR}	Avalanche Current ①	See Fig.12a,12b,15,16	А
E _{AR}	Repetitive Avalanche Energy ©		mJ
Т _Ј	Operating Junction and	-55 to + 175	°C
T _{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	
	Mounting torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	
Thermal Res	istance	;	•

	Parameter	Тур.	Max.	Units
R _{θJC}	Junction-to-Case ®		0.509	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
R _{eja}	Junction-to-Ambient		62	

 $\mathsf{HEXFET}^{\texttt{®}}$ is a registered trademark of International Rectifier.

*Qualification standards can be found at http://www.irf.com/

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	75			V	$V_{GS} = 0V, I_{D} = 250\mu A$
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.069		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		3.5	4.5	mΩ	V _{GS} = 10V, I _D = 75A ④
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
gfs	Forward Transconductance	180			S	$V_{DS} = 25V, I_D = 75A$
I _{DSS}	Drain-to-Source Leakage Current			20	μA	$V_{DS} = 75V, V_{GS} = 0V$
				250		$V_{DS} = 75V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			200	nA	V _{GS} = 20V
	Gate-to-Source Reverse Leakage			-200	[V _{GS} = -20V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q _g	Total Gate Charge		180	270		I _D = 75A
Q _{gs}	Gate-to-Source Charge		46		nC	$V_{DS} = 60V$
Q _{gd}	Gate-to-Drain ("Miller") Charge		65		Ī	V _{GS} = 10V ④
t _{d(on)}	Turn-On Delay Time		19		ns	$V_{DD} = 38V$
t _r	Rise Time		140		Ī	I _D = 75A
t _{d(off)}	Turn-Off Delay Time		97		Ī	$R_G = 2.5\Omega$
t _f	Fall Time		100			V _{GS} = 10V ④
L _D	Internal Drain Inductance		5.0		nH	Between lead,
						6mm (0.25in.)
L _S	Internal Source Inductance		13			from package of the second sec
						and center of die contact
C _{iss}	Input Capacitance		7500		pF	$V_{GS} = 0V$
C _{oss}	Output Capacitance		970			$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		510		Ī	f = 1.0MHz, See Fig. 5
C _{oss}	Output Capacitance		3640		Î	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C _{oss}	Output Capacitance		650			$V_{GS} = 0V, V_{DS} = 60V, f = 1.0MHz$
C _{oss} eff.	Effective Output Capacitance		1020			$V_{GS} = 0V, V_{DS} = 0V \text{ to } 60V$

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			75		MOSFET symbol
	(Body Diode)				А	showing the
I _{SM}	Pulsed Source Current			680		integral reverse
	(Body Diode) ①					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_{J} = 25^{\circ}C, I_{S} = 75A, V_{GS} = 0V$ (4)
t _{rr}	Reverse Recovery Time		41	61	ns	$T_J = 25^{\circ}C, I_F = 75A, V_{DD} = 38V$
Q _{rr}	Reverse Recovery Charge		59	89	nC	di/dt = 100A/µs ④
t _{on}	Forward Turn-On Time	Intrinsio	: turn-or	time is	negligib	le (turn-on is dominated by LS+LD)

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ② Limited by T_{Jmax} , starting T_J = 25°C, L=0.095mH, ⑦ This value determined from sample failure population, R_{G} = 25Ω, I_{AS} = 75A, V_{GS} =10V.
- Part not recommended for use above this value. $I_{SD} \leq 75A, di/dt \leq 340A/\mu s, V_{DD} \leq V_{(BR)DSS},$ $T_J \le 175^{\circ}C.$
- ④ Pulse width \leq 1.0ms; duty cycle \leq 2%.
- ⑤ Coss eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.
- © Limited by T_{Jmax} , see Fig.12a, 12b, 15, 16 for typical repetitive avalanche performance.
- starting $T_J = 25^{\circ}C$, L=0.095mH, $R_G = 25\Omega$, $I_{AS} = 75A$, $V_{GS} = 10V$.
- $\ensuremath{\$}$ R_{heta} is measured at T_J of approximately 90°C.
- In the second second

Qualification Information[†]

			Automotive			
		(per AEC-Q101) ^{††}				
Qualification Level		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensitivity	/ Level	TO-220AB N/A				
	Machine Model	Class M4 (425V)				
		AEC-Q101-002				
	Human Body Model	Class H2 (4000V)				
ESD		AEC-Q101-001				
	Charged Device Model	Class C4 (1000V)				
		AEC-Q101-005				
RoHS Compliant			Yes			

† Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

†† Exceptions to AEC-Q101 requirements are noted in the qualification report.

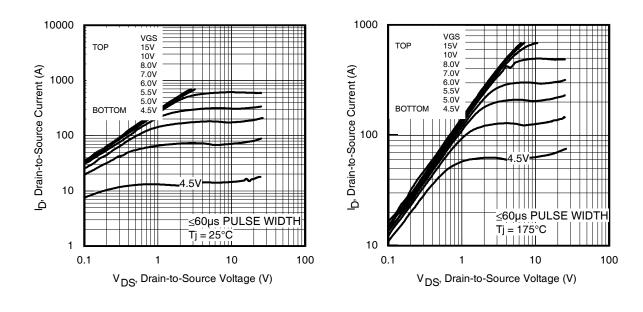


Fig 1. Typical Output Characteristics



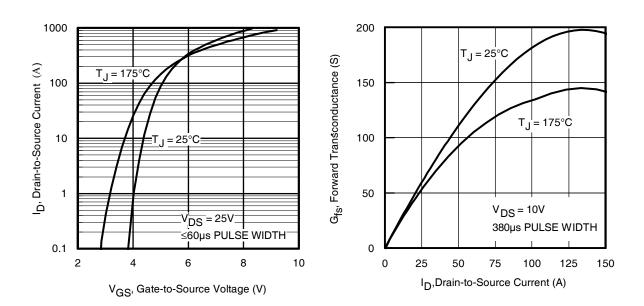


Fig 3. Typical Transfer Characteristics

Fig 4. Typical Forward Transconductance vs. Drain Current

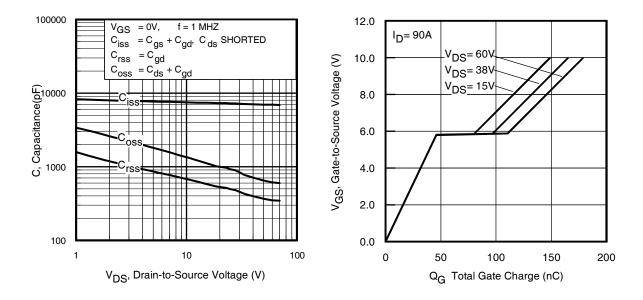
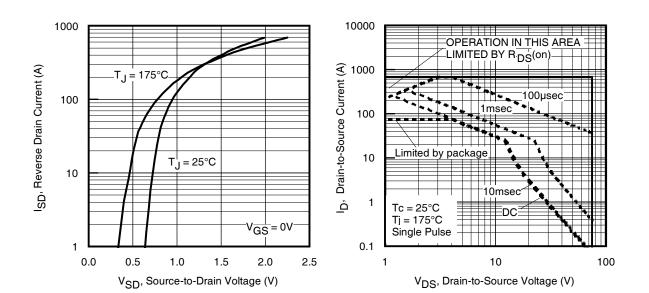


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage





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Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

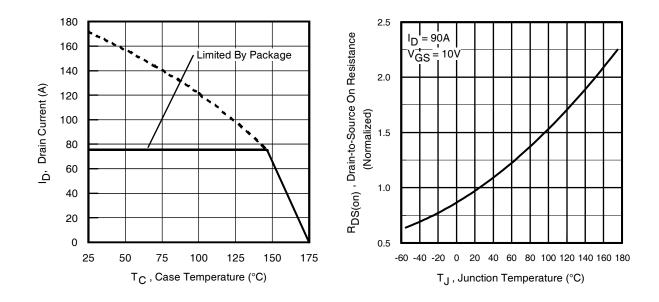


Fig 9. Maximum Drain Current vs. Case Temperature



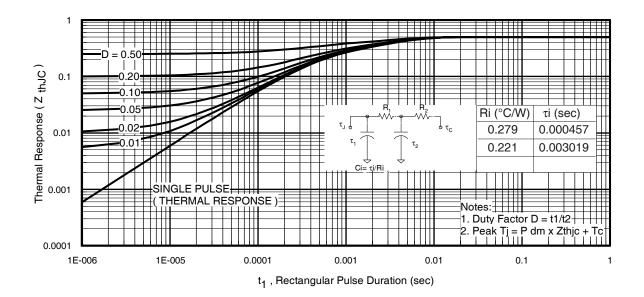


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

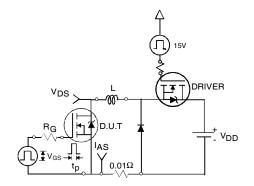


Fig 12a. Unclamped Inductive Test Circuit

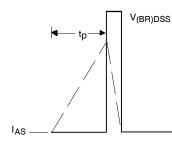


Fig 12b. Unclamped Inductive Waveforms

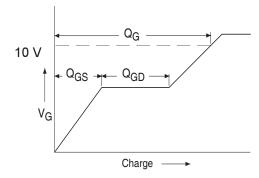
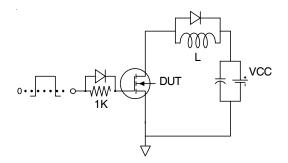


Fig 13a. Basic Gate Charge Waveform



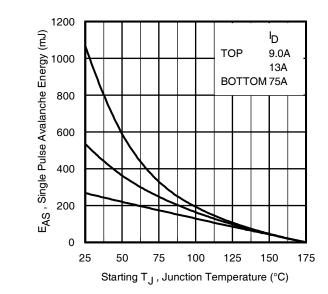


Fig 12c. Maximum Avalanche Energy vs. Drain Current

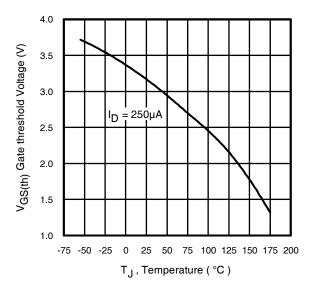


Fig 14. Threshold Voltage vs. Temperature

Fig 13b. Gate Charge Test Circuit www.irf.com

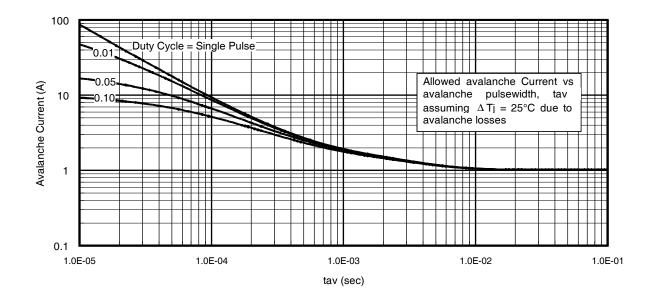


Fig 15. Typical Avalanche Current Vs.Pulsewidth

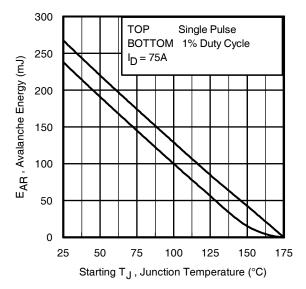


Fig 16. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 15, 16: (For further info, see AN-1005 at www.irf.com) 1. Avalanche failures assumption:

Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax}. This is validated for every part type.

- 2. Safe operation in Avalanche is allowed as long asT_{jmax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- 4. P_{D (ave)} = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 15, 16).
 - t_{av} = Average time in avalanche.
 - $D = Duty cycle in avalanche = t_{av} \cdot f$
 - $Z_{\text{thJC}}(D, t_{\text{av}}) = \text{Transient thermal resistance, see figure 11}$

$$\begin{split} P_{D~(ave)} &= 1/2~(~1.3{\cdot}BV{\cdot}I_{av}) = {{\bigtriangleup}T/~Z_{thJC}}\\ I_{av} &= 2{{\bigtriangleup}T/~[1.3{\cdot}BV{\cdot}Z_{th}]}\\ E_{AS~(AR)} &= P_{D~(ave)}{\cdot}t_{av} \end{split}$$

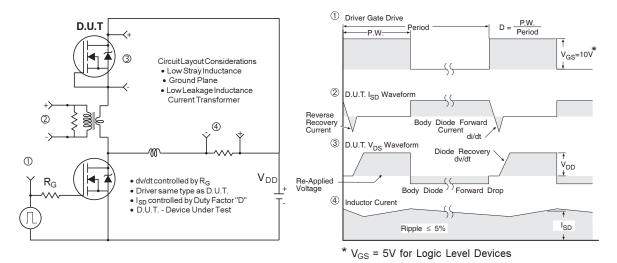


Fig 17. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET[®] Power MOSFETs

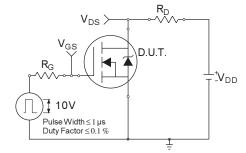


Fig 18a. Switching Time Test Circuit

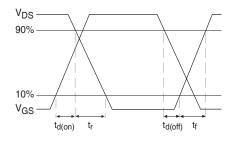
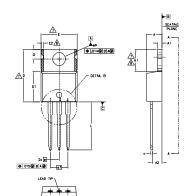
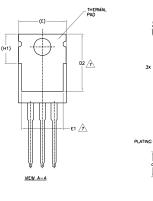


Fig 18b. Switching Time Waveforms

TO-220AB Package Outline

Dimensions are shown in millimeters (inches)







(b, b2)

BASE META 1/5

ß ь1,ь3 SECTION C-C & D-D NOTES:

- 1.-2.-3.-4.-

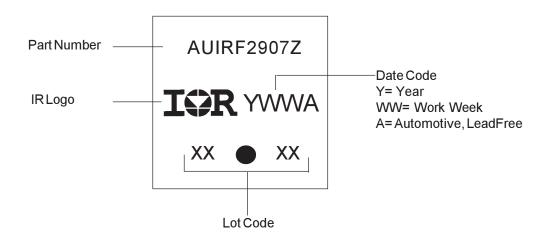
8.-

9,-

WHER	E DIMENSIONS	ARE DERIVED	FROM THE ACT	UAL PACKAGE	OUTLINE.
		DIMEN	ISIONS		
SYMBOL	MILLIM	ETERS	INCI		
	Min.	MAX.	MIN.	MAX.	NOTES
A	3,56	4.83	,140	.190	
A1	0.51	1.40	.020	.055	
A2	2.03	2.92	.080	.115	
b	0.38	1.01	.015	.040	
ь1	0.38	0.97	.015	.038	5
b2	1.14	1.7B	.045	.070	
b3	1,14	1,73	.045	.068	5
с	0.36	0.61	.014	.024	
c1	0.36	0.56	.014	.022	5
D	14.22	16.51	.560	.650	4
D1	8,38	9.02	.330	.355	
D2	11.68	12.88	.460	.507	7
Ε	9.65	10,67	.380	.420	4,7
E1	6.86	8.89	.270	.350	7
E2	-	0.76	-	.030	8
е	2.54	2.54 BSC 5.08 BSC		BSC	
e1			.200 BSC		
HI	5,84	6.86	.230	.270	7,8
L	12.70	14.73	.500	.580	
LÍ	3,56	4,06	,140	.160	3
øP	3.54	4.08	.139	.161	
Q	2.54	3.42	,100	.135	

HEXFET CHRANK 1.- GATE 2.- Collector 3.- E**W**ITER 1.- ANODE 2.- CATHOD

TO-220AB Part Marking Information



TO-220AB packages are not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRF2907Z	TO-220	Tube	50	AUIRF2907Z

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